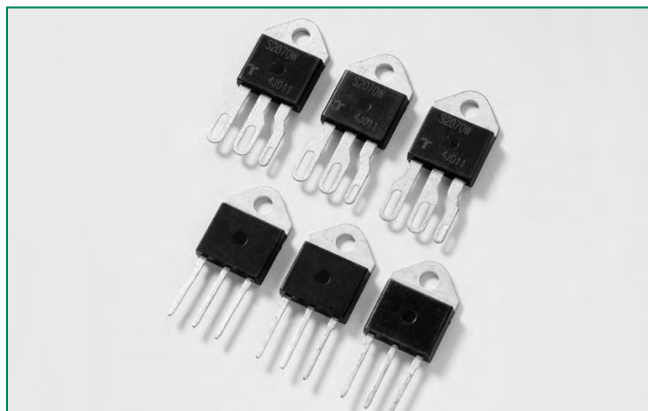


## Oxx40xx Series



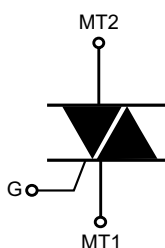
### Agency Approval

| Agency | Agency File Number     |
|--------|------------------------|
|        | K & J Packages: E71639 |

### Main Features

| Symbol            | Value       | Unit |
|-------------------|-------------|------|
| $I_{T(RMS)}$      | 40          | A    |
| $V_{DRM}/V_{RRM}$ | 400 to 1000 | V    |
| $I_{GT(Q1)}$      | 50 to 100   | mA   |

### Schematic Symbol



### Description

The 40 Amp bi-directional solid state switch series is designed for AC switching and phase control applications such as motor speed, temperature modulation controls, lighting controls, and static switching relays.

Alternistor type devices only operate in quadrants I, II, & III and are used in circuits requiring high dv/dt capability.

### Features & Benefits

- RoHS Compliant
- Glass – passivated junctions
- Voltage capability up to 1000V
- Surge capability up to 400A
- Electrically isolated K & J -Packages are UL recognized for 2500Vrms

### Applications

Excellent for AC switching and phase control applications such as heating, lighting, and motor speed controls.

Typical applications are AC solid-state switches, industrial power tools, exercise equipment, white goods and commercial appliances.

Alternistor Triacs (no snubber required) are used in applications with extremely inductive loads requiring highest commutation performance.

Internally constructed isolated packages are offered for ease of heat sinking with highest isolation voltage.

### Additional Information



**Datasheet**



**Resources**



**Samples**

### Absolute Maximum Ratings — Alternistor Triac (3 Quadrants)

| Symbol       | Parameter                                                                                       |                                                 |                           | Value      | Unit                   |
|--------------|-------------------------------------------------------------------------------------------------|-------------------------------------------------|---------------------------|------------|------------------------|
| $I_{T(RMS)}$ | RMS on-state current (full sine wave)                                                           | Qxx40x7<br>Qxx40xH6                             | $T_c = 75^\circ\text{C}$  | 40         | A                      |
| $I_{TSM}$    | Non repetitive surge peak on-state current<br>(full cycle, $T_J$ initial = $25^\circ\text{C}$ ) | f = 50 Hz                                       | t = 20 ms                 | 335        | A                      |
|              |                                                                                                 | f = 60 Hz                                       | t = 16.7 ms               | 400        |                        |
| $I^2t$       | $I^2t$ Value for fusing                                                                         |                                                 | $t_p = 8.3$ ms            | 664        | $\text{A}^2\text{s}$   |
| di/dt        | Critical rate of rise of on-state current<br>( $I_G = 2 \times I_{GT}$ , $t_r \leq 100$ ns)     | f = 120 Hz                                      | $T_J = 125^\circ\text{C}$ | 150        | $\text{A}/\mu\text{s}$ |
| $I_{GTM}$    | Peak gate trigger current                                                                       | $t_p \leq 10 \mu\text{s}$ $I_{GT} \leq I_{GTM}$ | $T_J = 125^\circ\text{C}$ | 4          | A                      |
| $P_{G(AV)}$  | Average gate power dissipation                                                                  |                                                 | $T_J = 125^\circ\text{C}$ | 0.8        | W                      |
| $T_{stg}$    | Storage temperature range                                                                       |                                                 |                           | -40 to 150 | $^\circ\text{C}$       |
| $T_J$        | Operating junction temperature range                                                            |                                                 |                           | -40 to 125 | $^\circ\text{C}$       |

Note: xx = voltage, x = package

### Electrical Characteristics ( $T_J = 25^\circ\text{C}$ , unless otherwise specified) — Alternistor Triac (3 Quadrants)

| Symbol   | Test Conditions                                                        | Quadrant     |      | Value    |         |         | Unit                   |
|----------|------------------------------------------------------------------------|--------------|------|----------|---------|---------|------------------------|
|          |                                                                        |              |      | Qxx40xH6 | Qxx40K5 | Qxx40x7 |                        |
| $I_{GT}$ | $V_D = 12\text{V}$ $R_L = 60 \Omega$                                   | I – II – III | MAX. | 80       | 50      | 100     | mA                     |
| $V_{GT}$ | $V_D = 12\text{V}$ $R_L = 60 \Omega$                                   | I – II – III | MAX. | 1.3      | 1.3     | 2.0     | V                      |
| $V_{GD}$ | $V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ $T_J = 125^\circ\text{C}$  | I – II – III | MIN. | 0.2      |         |         | V                      |
| $I_H$    | $I_T = 400\text{mA}$                                                   |              | MAX. | 80       | 75      | 100     | mA                     |
| dv/dt    | $V_D = V_{DRM}$ Gate Open $T_J = 125^\circ\text{C}$                    | 400V         | MIN. | 600      | 500     | 700     | $\text{V}/\mu\text{s}$ |
|          |                                                                        | 600V         |      | 500      | 475     | 625     |                        |
|          |                                                                        | 800V         |      | 475      | 400     | 575     |                        |
|          | $V_D = V_{DRM}$ Gate Open $T_J = 100^\circ\text{C}$                    | 1000V        |      | --       | --      | 500     |                        |
| (dv/dt)c | (di/dt)c = 21.6 A/ms $T_J = 125^\circ\text{C}$                         |              | MIN. | 30       | 20      | 50      | $\text{V}/\mu\text{s}$ |
| $t_{gt}$ | $I_G = 2 \times I_{GT}$ PW = 15 $\mu\text{s}$ $I_T = 56.6\text{A(pk)}$ |              | TYP. | 5        |         |         | $\mu\text{s}$          |

### Static Characteristics

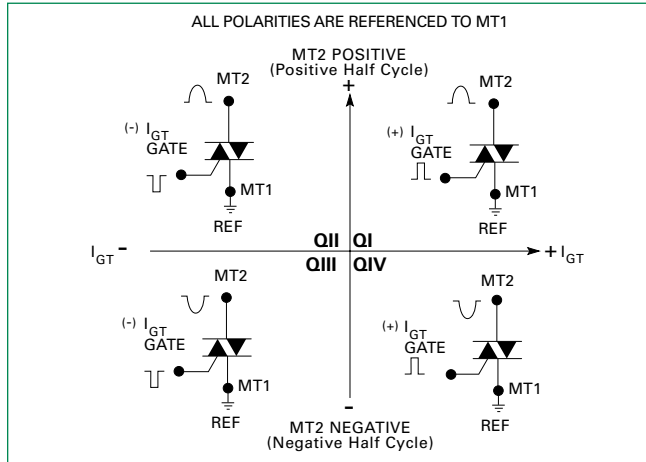
| Symbol          | Test Conditions                                 |                           |             | Value | Unit             |
|-----------------|-------------------------------------------------|---------------------------|-------------|-------|------------------|
| $V_{TM}$        | $I_{TM} = 56.6\text{A}$ $t_p = 380 \mu\text{s}$ | $T_J = 25^\circ\text{C}$  | MAX.        | 1.8   | V                |
| $I_{RRM}^{DRM}$ | $V_D = V_{DRM} / V_{RRM}$                       | $T_J = 25^\circ\text{C}$  | 400 – 1000V | MAX.  | 20 $\mu\text{A}$ |
|                 |                                                 | $T_J = 125^\circ\text{C}$ | 400 – 800V  | MAX.  | 5 mA             |
|                 |                                                 | $T_J = 100^\circ\text{C}$ | 1000V       | MAX.  | 5 mA             |

### Thermal Resistances

| Symbol            | Parameter             |                                | Value | Unit                      |
|-------------------|-----------------------|--------------------------------|-------|---------------------------|
| $R_{\theta(J-C)}$ | Junction to case (AC) | Qxx40KH6<br>Qxx40K5<br>Qxx40K7 | 0.97  | $^\circ\text{C}/\text{W}$ |
|                   |                       | Qxx40JH6<br>Qxx40J7            | 0.95  |                           |

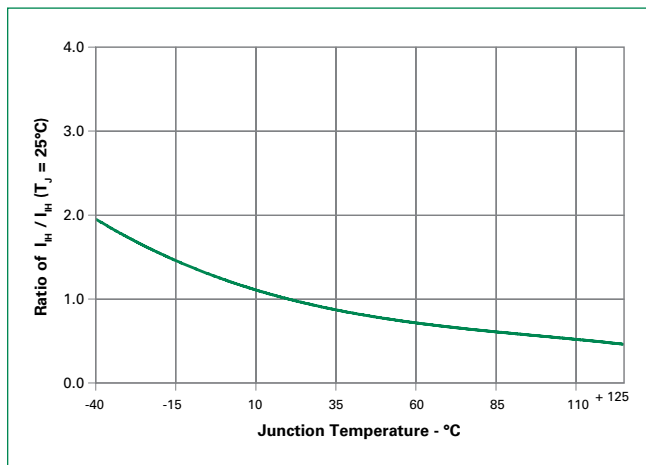
Note: xx = voltage

**Figure 1: Definition of Quadrants**

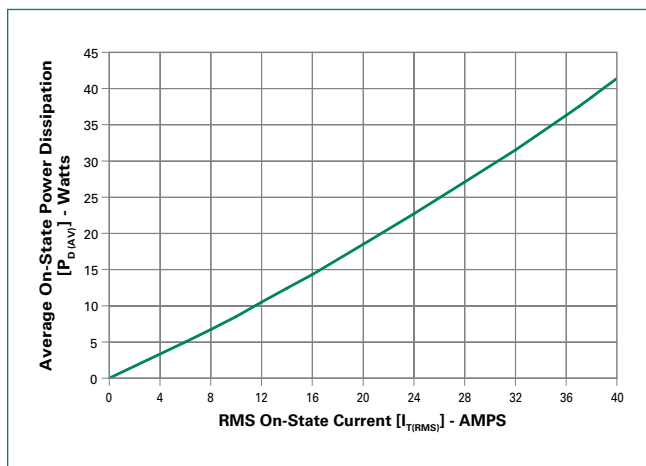


Note: Alternistors will not operate in QIV

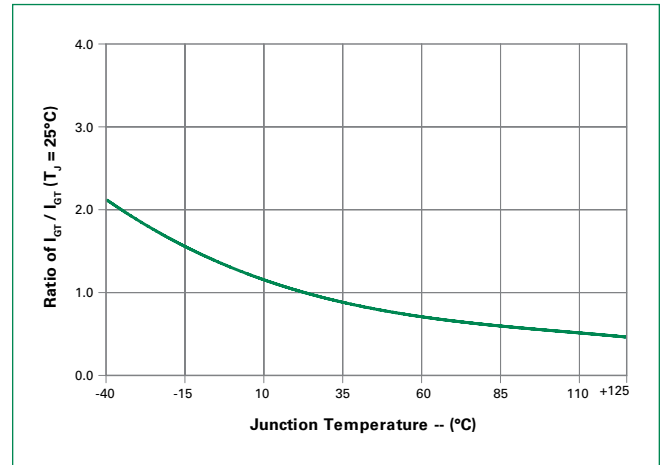
**Figure 3: Normalized DC Holding Current vs. Junction Temperature**



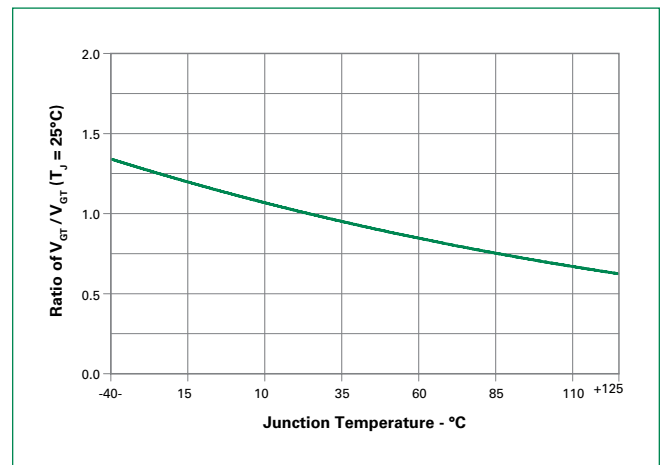
**Figure 5: Power Dissipation (Typical) vs. RMS On-State Current**



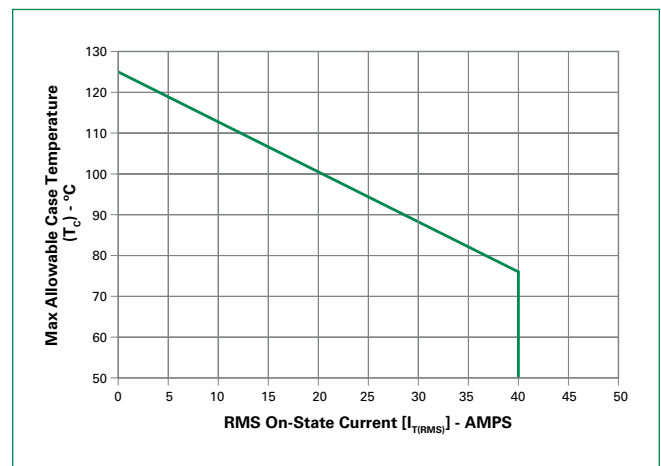
**Figure 2: Normalized DC Gate Trigger Current for All Quadrants vs. Junction Temperature**



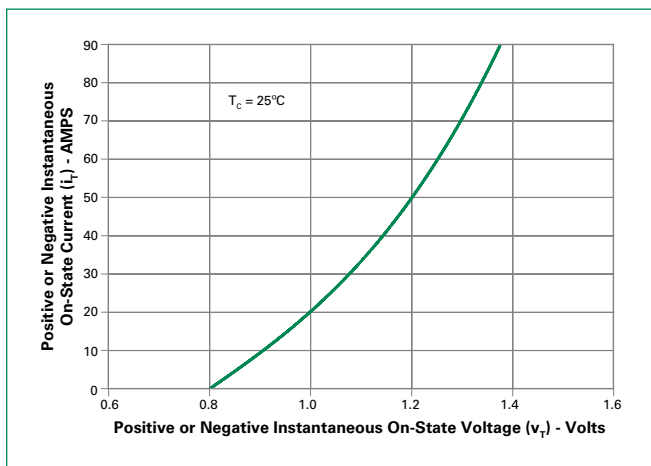
**Figure 4: Normalized DC Gate Trigger Voltage for All Quadrants vs. Junction Temperature**



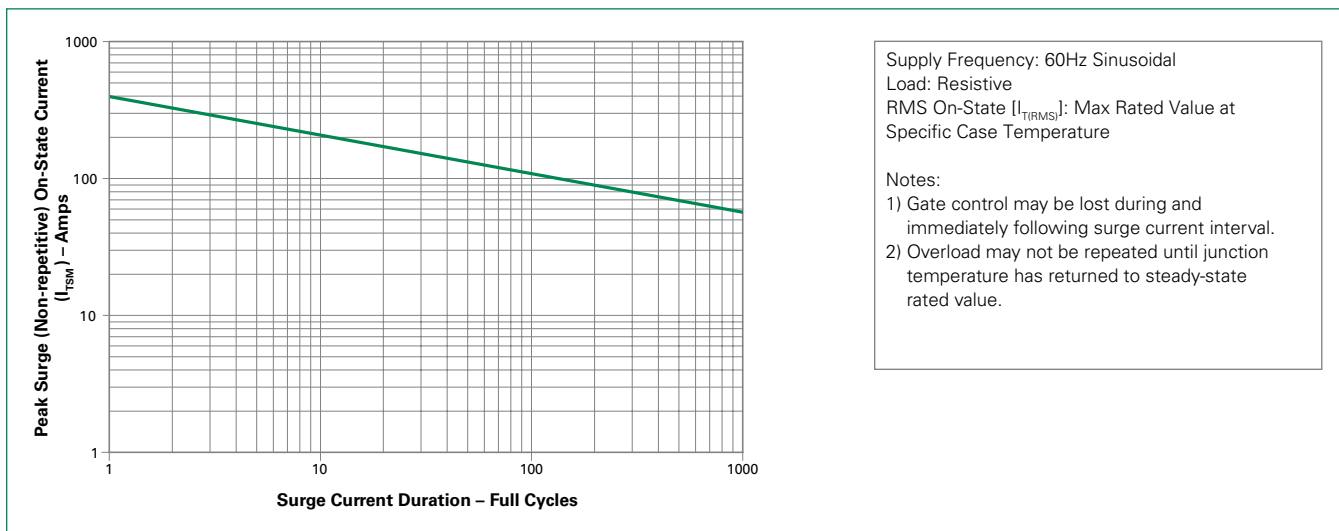
**Figure 6: Maximum Allowable Case Temperature vs. On-State Current**



**Figure 7: On-State Current vs. On-State Voltage (Typical)**



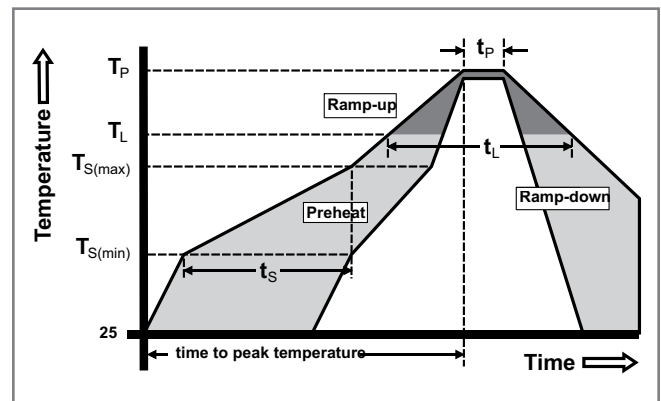
**Figure 8: Surge Peak On-State Current vs. Number of Cycles**



Note: xx = voltage

### Soldering Parameters

|                                                        |                                    |                         |
|--------------------------------------------------------|------------------------------------|-------------------------|
| Reflow Condition                                       |                                    | Pb – Free assembly      |
| Pre Heat                                               | - Temperature Min ( $T_{s(min)}$ ) | 150°C                   |
|                                                        | - Temperature Max ( $T_{s(max)}$ ) | 200°C                   |
|                                                        | - Time (min to max) ( $t_s$ )      | 60 – 180 secs           |
| Average ramp up rate (Liquidus Temp) ( $T_L$ ) to peak |                                    | 5°C/second max          |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                   |                                    | 5°C/second max          |
| Reflow                                                 | - Temperature ( $T_L$ ) (Liquidus) | 217°C                   |
|                                                        | - Time (min to max) ( $t_s$ )      | 60 – 150 seconds        |
| Peak Temperature ( $T_p$ )                             |                                    | 260 <sup>+0/-5</sup> °C |
| Time within 5°C of actual peak Temperature ( $t_p$ )   |                                    | 20 – 40 seconds         |
| Ramp-down Rate                                         |                                    | 5°C/second max          |
| Time 25°C to peak Temperature ( $T_p$ )                |                                    | 8 minutes Max.          |
| Do not exceed                                          |                                    | 280°C                   |



### Physical Specifications

|                        |                                                                |
|------------------------|----------------------------------------------------------------|
| <b>Terminal Finish</b> | 100% Matte Tin-plated.                                         |
| <b>Body Material</b>   | UL recognized epoxy meeting flammability classification 94V-0. |
| <b>Lead Material</b>   | Copper Alloy                                                   |

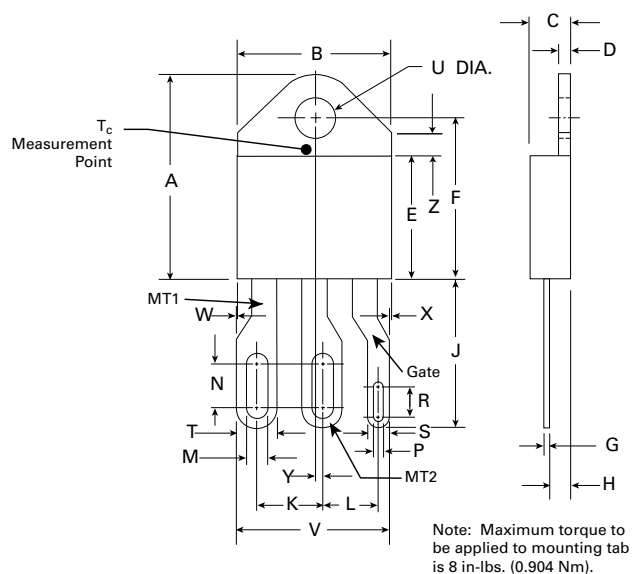
### Design Considerations

Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including  $dv/dt$ ), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

### Environmental Specifications

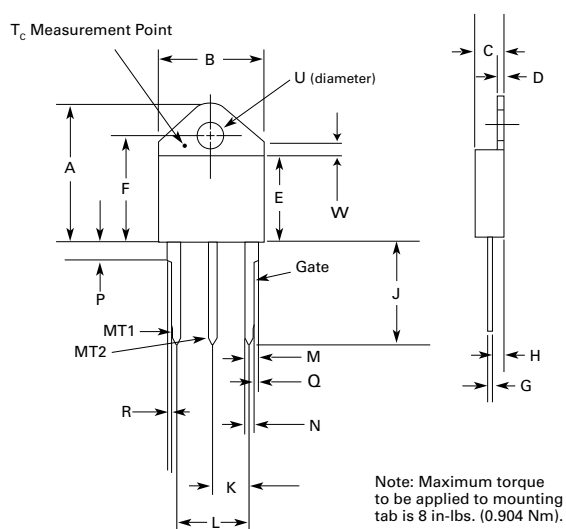
| Test                             | Specifications and Conditions                                              |
|----------------------------------|----------------------------------------------------------------------------|
| <b>AC Blocking</b>               | MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours |
| <b>Temperature Cycling</b>       | MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time        |
| <b>Temperature/Humidity</b>      | EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity     |
| <b>High Temp Storage</b>         | MIL-STD-750, M-1031, 1008 hours; 150°C                                     |
| <b>Low-Temp Storage</b>          | 1008 hours; -40°C                                                          |
| <b>Resistance to Solder Heat</b> | MIL-STD-750 Method 2031                                                    |
| <b>Solderability</b>             | ANSI/J-STD-002, category 3, Test A                                         |
| <b>Lead Bend</b>                 | MIL-STD-750, M-2036 Cond E                                                 |

**Dimensions — TO-218X (J Package) — Isolated Mounting Tab**



| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min    | Max   | Min         | Max   |
| A         | 0.810  | 0.835 | 20.57       | 21.21 |
| B         | 0.610  | 0.630 | 15.49       | 16.00 |
| C         | 0.178  | 0.188 | 4.52        | 4.78  |
| D         | 0.055  | 0.070 | 1.40        | 1.78  |
| E         | 0.487  | 0.497 | 12.37       | 12.62 |
| F         | 0.635  | 0.655 | 16.13       | 16.64 |
| G         | 0.022  | 0.029 | 0.56        | 0.74  |
| H         | 0.075  | 0.095 | 1.91        | 2.41  |
| J         | 0.575  | 0.625 | 14.61       | 15.88 |
| K         | 0.256  | 0.264 | 6.50        | 6.71  |
| L         | 0.220  | 0.228 | 5.58        | 5.79  |
| M         | 0.080  | 0.088 | 2.03        | 2.24  |
| N         | 0.169  | 0.177 | 4.29        | 4.49  |
| P         | 0.034  | 0.042 | 0.86        | 1.07  |
| R         | 0.113  | 0.121 | 2.87        | 3.07  |
| S         | 0.086  | 0.096 | 2.18        | 2.44  |
| T         | 0.156  | 0.166 | 3.96        | 4.22  |
| U         | 0.161  | 0.165 | 4.10        | 4.20  |
| V         | 0.603  | 0.618 | 15.31       | 15.70 |
| W         | 0.000  | 0.005 | 0.00        | 0.13  |
| X         | 0.003  | 0.012 | 0.07        | 0.30  |
| Y         | 0.028  | 0.032 | 0.71        | 0.81  |
| Z         | 0.085  | 0.095 | 2.17        | 2.42  |

**Dimensions — TO-218AC (K Package) — Isolated Mounting Tab**



| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min    | Max   | Min         | Max   |
| A         | 0.810  | 0.835 | 20.57       | 21.21 |
| B         | 0.610  | 0.630 | 15.49       | 16.00 |
| C         | 0.178  | 0.188 | 4.52        | 4.78  |
| D         | 0.055  | 0.070 | 1.40        | 1.78  |
| E         | 0.487  | 0.497 | 12.37       | 12.62 |
| F         | 0.635  | 0.655 | 16.13       | 16.64 |
| G         | 0.022  | 0.029 | 0.56        | 0.74  |
| H         | 0.075  | 0.095 | 1.91        | 2.41  |
| J         | 0.575  | 0.625 | 14.61       | 15.88 |
| K         | 0.211  | 0.219 | 5.36        | 5.56  |
| L         | 0.422  | 0.437 | 10.72       | 11.10 |
| M         | 0.058  | 0.068 | 1.47        | 1.73  |
| N         | 0.045  | 0.055 | 1.14        | 1.40  |
| P         | 0.095  | 0.115 | 2.41        | 2.92  |
| Q         | 0.008  | 0.016 | 0.20        | 0.41  |
| R         | 0.008  | 0.016 | 0.20        | 0.41  |
| U         | 0.161  | 0.165 | 4.10        | 4.20  |
| W         | 0.085  | 0.095 | 2.17        | 2.42  |

## Product Selector

| Part Number | Voltage |      |      |       | Gate Sensitivity Quadrants |    | I <sub>T(RMS)</sub> | Type              | Package  |
|-------------|---------|------|------|-------|----------------------------|----|---------------------|-------------------|----------|
|             | 400V    | 600V | 800V | 1000V | I – II – III               | IV |                     |                   |          |
| Qxx40KH6    | X       | X    | X    | X     | 80mA                       |    | 40A                 | Alternistor Triac | TO-218AC |
| Qxx40JH6    | X       | X    | X    |       | 80mA                       |    | 40A                 | Alternistor Triac | TO-218X  |
| Qxx40K5     | X       | X    | X    |       | 50mA                       |    | 40A                 | Alternistor Triac | TO-218AC |
| Qxx40K7     | X       | X    | X    | X     | 100 mA                     |    | 40A                 | Alternistor Triac | TO-218AC |
| Qxx40J7     | X       | X    | X    |       | 100 mA                     |    | 40A                 | Alternistor Triac | TO-218X  |

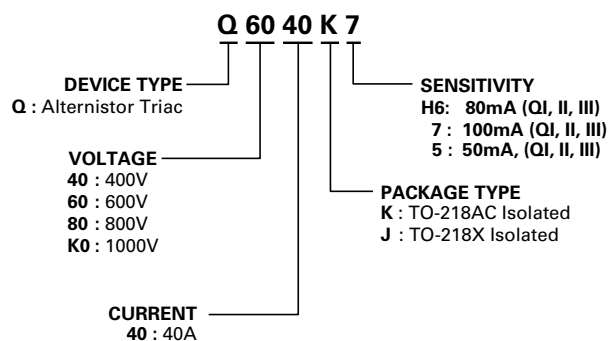
Note: xx = Voltage

## Packing Options

| Part Number | Marking  | Weight | Packing Mode | Base Quantity     |
|-------------|----------|--------|--------------|-------------------|
| Qxx40KH6TP  | Qxx40KH6 | 4.40g  | Tube         | 250 (25 per tube) |
| Qxx40JH6TP  | Qxx40JH6 | 5.23g  | Tube         | 250 (25 per tube) |
| Qxx40K5TP   | Qxx40K5  | 4.40g  | Tube         | 250 (25 per tube) |
| Qxx40K7TP   | Qxx40K7  | 4.40g  | Tube         | 250 (25 per tube) |
| Qxx40J7TP   | Qxx40J7  | 5.23g  | Tube         | 250 (25 per tube) |

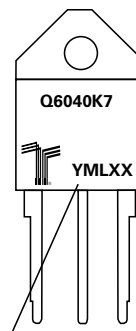
Note: xx = Voltage

## Part Numbering System



## Part Marking System

TO-218 AC - (K Package)  
TO-218 X - (J Package)



Date Code Marking  
Y: Year Code  
M: Month Code  
L: Location Code  
XX: Lot Serial Code

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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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ВЧ соединители, коаксиальные кабели,  
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